查询74LV273D供应剂

DATA SHEET

74LV273

Octal D-type flip-flop with reset; positive-edge trigger

Product specification
Supersedes data of 1997 Apr 07
IC24 Data Handbook

1998 May 29







Octal D-type flip-flop with reset; positive edge-trigger

74LV273

FEATURES

- Wide operating voltage: 1.0 to 5.5V
- Optimized for Low Voltage applications: 1.0 to 3.6V
- Accepts TTL input levels between V_{CC} = 2.7V and V_{CC} = 3.6V
- Typical V_{OLP} (output ground bounce) < 0.8V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Ideal buffer for MOS microprocessor or memory
- Common clock and master reset
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV273 is a low-voltage Si-gate CMOS device and is pin and function compatible with the 74HC/HCT273.

The 74LV273 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common clock (CP) and master reset (MR) inputs load and reset (clear) all flip-flops simultaneously. The state of each D input, one set-up time before the LOW-to-HIGH clock transition, is transferred to the corresponding output (Qn) of the flip-flop.

All outputs will be forced LOW independently of clock or data inputs by a LOW voltage level on the MR input.

The device is useful for applications where the true output only is required and the clock and master reset are common to all storage elements.

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|------------------------------------|--|---|----------|------|
| t _{PHL} /t _{PLH} | Propagation delay CP to Q_{n} ; \overline{MR} to Q_{n} | C _L = 15pF V _{CC} = 3.3V | 12 13 | ns |
| f _{max} | Maximum clock frequency |] | 110 | MHz |
| C _I | Input capacitance | | 3.5 | pF |
| C _{PD} | Power dissipation capacitance per flip-flop | Notes 1 and 2 | 20 | pF |

NOTES:

C_{PD} is used to determine the dynamic power dissipation (P_D in μW) P_D = C_{PD} × V_{CC}² x f_i + Σ (C_L × V_{CC}² x f_o) where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V; Σ (C_L × V_{CC}² × f_o) = sum of the outputs.
 The condition is V_I = GND to V_{CC}

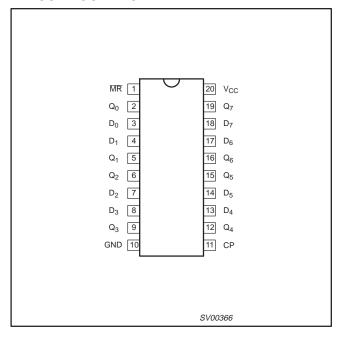
ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | PKG. DWG. # |
|-----------------------------|-------------------|-----------------------|---------------|-------------|
| 20-Pin Plastic DIL | -40°C to +125°C | 74LV273 N | 74LV273 N | SOT146-1 |
| 20-Pin Plastic SO | –40°C to +125°C | 74LV273 D | 74LV273 D | SOT163-1 |
| 20-Pin Plastic SSOP Type II | -40°C to +125°C | 74LV273 DB | 74LV273 DB | SOT339-1 |
| 20-Pin Plastic TSSOP | -40°C to +125°C | 74LV273 PW | 74LV273PW DH | SOT360-1 |

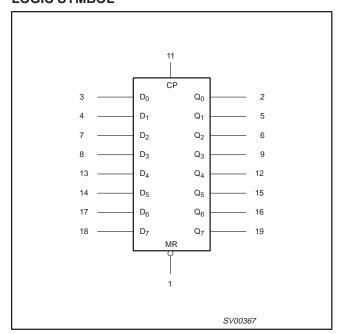
Octal D-type flip-flop with reset; positive edge-trigger

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PIN CONFIGURATION



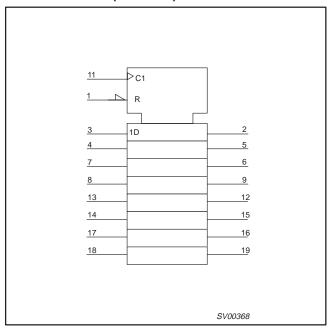
LOGIC SYMBOL



PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION |
|-------------------------------|----------------------------------|---|
| 1 | MR | Master reset input (active-LOW) |
| 2, 5, 6, 9, 12, 15, 16, 19 | Q ₀ to Q ₇ | Flip-flop outputs |
| 3, 4, 7, 8, 13, 14, 17, 18 | D ₀ to D ₇ | Data inputs |
| 10 | GND | Ground (0V) |
| 11 | СР | Clock input (LOW-to-HIGH, edge-triggered) |
| 20 | V _{CC} | Positive supply voltage |

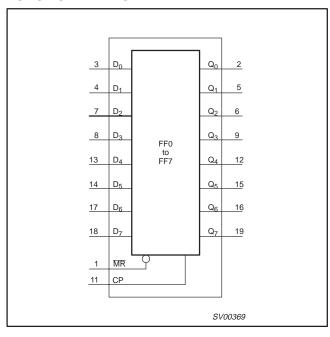
LOGIC SYMBOL (IEEE/IEC)



Octal D-type flip-flop with reset; positive edge-trigger

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FUNCTIONAL DIAGRAM



FUNCTION TABLE

| OPERATING MODES | | INPUTS | | OUTPUTS |
|-----------------|----|------------|----------------|----------------------------------|
| OPERATING MODES | MR | СР | D _n | Q ₀ to Q ₇ |
| Reset (clear) | L | Х | Х | L |
| Load ('1') | Н | 1 | h | Н |
| Load ('0') | Н | \uparrow | I | L |

= HIGH voltage level

HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition h

LOW voltage level
LOW voltage level one set-up time prior to the
LOW-to-HIGH CP transition

LOW-to-HIGH clock transition

= Don't care

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP. | MAX | UNIT |
|---------------------------------|---|---|-------------|------------------|-------------------------|------|
| V _{CC} | DC supply voltage | See Note1 | 1.0 | 3.3 | 5.5 | V |
| VI | Input voltage | | 0 | - | V _{CC} | V |
| Vo | Output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | Operating ambient temperature range in free air | See DC and AC characteristics | -40 -40 | | +85 +125 | °C |
| t _r , t _f | Input rise and fall times | $\begin{array}{c} V_{CC} = 1.0 \text{V to } 2.0 \text{V} \\ V_{CC} = 2.0 \text{V to } 2.7 \text{V} \\ V_{CC} = 2.7 \text{V to } 3.6 \text{V} \\ V_{CC} = 3.6 \text{V to } 5.5 \text{V} \end{array}$ | - - - | - - - - | 500 200 100 50 | ns/V |

^{1.} The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|---|--|---|-------------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +7.0 | V |
| ±I _{IK} | DC input diode current | $V_I < -0.5 \text{ or } V_I > V_{CC} + 0.5V$ | 20 | mA |
| ±I _{OK} | DC output diode current | $V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5 V$ | 50 | mA |
| ±I _O | DC output source or sink current – standard outputs | $-0.5V < V_O < V_{CC} + 0.5V$ | 25 | mA |
| ±I _{GND} , ±I _{CC} | DC V _{CC} or GND current for types with –standard outputs | | 50 | mA |
| T _{stg} | Storage temperature range | | -65 to +150 | °C |
| P _{TOT} | Power dissipation per package -plastic DIL -plastic mini-pack (SO) -plastic shrink mini-pack (SSOP and TSSOP) | for temperature range: -40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K | 750 500 400 | mW |

NOTES:

DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

| | | | | | LIMITS | | | | |
|----------|--|--|---------------------|------------------|---------------------|---------------------|---------------------|----------|--|
| SYMBOL | PARAMETER | TEST CONDITIONS | -40 |)°C to +8 | 5°C | -40°C to | +125°C | דואט 🛮 | |
| | | | MIN | TYP ¹ | MAX | MIN | MAX | 1 | |
| | | V _{CC} = 1.2V | 0.9 | | | 0.9 | | | |
| V_{IH} | HIGH level Input | V _{CC} = 2.0V | 1.4 | | | 1.4 | |] , | |
| VIН | voltage | V _{CC} = 2.7 to 3.6V | 2.0 | | | 2.0 | | 1 ° | |
| | | V _{CC} = 4.5 to 5.5V | 0.7*V _{CC} | | | 0.7*V _{CC} | | 1 | |
| | | V _{CC} = 1.2V | | | 0.3 | | 0.3 | | |
| V_{IL} | LOW level Input | V _{CC} = 2.0V | | | 0.6 | | 0.6 |] , | |
| VIL | voltage | V _{CC} = 2.7 to 3.6V | | | 0.8 | | 0.8 | 1 ° | |
| | | V _{CC} = 4.5 to 5.5 | | | 0.3*V _{CC} | | 0.3*V _{CC} | 1 | |
| | | $V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | | 1.2 | | | | | |
| | | $V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 1.8 | 2.0 | | 1.8 | | 1 | |
| | HIGH level output voltage; all outputs | $V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$ | 2.5 | 2.7 | | 2.5 | | V | |
| ., | voltago, all outputo | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 2.8 | 3.0 | | 2.8 | | 1 | |
| V_{OH} | | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$ | 4.3 | 4.5 | | 4.3 | | 1 | |
| | HIGH level output voltage; | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 6\text{mA}$ | 2.40 | 2.82 | | 2.20 | | V | |
| | STANDARD outputs | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 12\text{mA}$ | 3.60 | 4.20 | | 3.50 | | | |
| | | $V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | | | | | |
| | LOW/ loved oversit | $V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$ | | 0 | 0.2 | | 0.2 |] | |
| | LOW level output voltage; all outputs | $V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 | V | |
| ., | | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 |] | |
| VOL | V _{OL} | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$ | | 0 | 0.2 | | 0.2 | | |
| | LOW level output voltage; | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6\text{mA}$ | | 0.25 | 0.40 | | 0.50 | V | |
| | STANDARD outputs | $V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 12\text{mA}$ | | 0.35 | 0.55 | | 0.65 | ľ | |

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC CHARACTERISTICS FOR THE LV FAMILY (Continued)

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | | | | | |
|------------------|---|---|--------|----------|------|----------|------|----|--|--|
| STWIDOL | TANAMETER | TEST CONDITIONS | -40 | °C to +8 | 5°C | -40°C to | UNIT | | | |
| lı | Input leakage current | $V_{CC} = 5.5V$; $V_I = V_{CC}$ or GND | | | 1.0 | | 1.0 | μА | | |
| I _{CC} | Quiescent supply current; MSI | $V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$ | | | 20.0 | | 160 | μΑ | | |
| Δl _{CC} | Additional quiescent supply current per input | $V_{CC} = 2.7V$ to 3.6V; $V_I = V_{CC} - 0.6V$ | | | 500 | | 850 | μА | | |

NOTE

AC CHARACTERISTICS

GND = 0V; t_{f} = t_{f} = 2.5ns; C_{L} = 50pF; R_{L} = 1K Ω

| SYMBOL | PARAMETER | WAVEFORM | CONDITION | _ | LIMITS 40 to +85 ° | C | LIM -40 to - | | UNIT |
|------------------------------------|---|----------|---------------------|-----|-----------------------|-----|-----------------|-----|------|
| | | | V _{CC} (V) | MIN | TYP ¹ | MAX | MIN | MAX | |
| | | | 1.2 | - | 75 | - | - | - | |
| | | | 2.0 | _ | 26 | 32 | - | 41 | |
| t _{PHL} /t _{PLH} | Propagation delay CP to Q _n | Figure 1 | 2.7 | _ | 19 | 24 | _ | 30 | ns |
| | 0. 10 4 | | 3.0 to 3.6 | T - | 14 ² | 19 | - | 24 | |
| | | | 4.5 to 5.5 | _ | _ | 16 | _ | 20 | |
| | | | 1.2 | _ | 80 | _ | _ | _ | |
| | Barranette e delec | | 2.0 | - | 27 | 44 | - | 56 | |
| t _{PHL} | Propagation delay MR to Q _n | Figure 2 | 2.7 | T - | 20 | 33 | - | 41 | ns |
| | | | 3.0 to 3.6 | Ι- | 15 ² | 26 | - | 33 | |
| | | | 4.5 to 5.5 | - | - | 22 | - | 28 | |
| | | | 2.0 | 34 | 9 | - | 41 | _ | |
| t_{W} | Clock pulse width HIGH or LOW | Figure 1 | 2.7 | 25 | 6 | - | 30 | - | ns |
| | 1011 01 2011 | l | 3.0 to 3.6 | 20 | 5 ² | - | 24 | - | |
| | | | 2.0 | 34 | 10 | - | 41 | - | |
| t_W | Master reset pulse width LOW | Figure 2 | 2.7 | 25 | 8 | - | 30 | - | ns |
| | Widan 2011 | l | 3.0 to 3.6 | 20 | 6 ² | - | 24 | - | |
| | | | 1.2 | - | -10 | - | - | - | |
| 4 | Removal time | Figure 2 | 2.0 | 5 | -4 | - | 5 | - | ns |
| t _{rem} | MR to CP | Figure 2 | 2.7 | 5 | -3 | - | 5 | - | 115 |
| | | l | 3.0 to 3.6 | 5 | -2 ² | - | 5 | - | |
| | | | 1.2 | - | 20 | - | - | - | |
| | Set-up time | Figure 3 | 2.0 | 22 | 7 | - | 26 | - | 20 |
| t _{su} | D _n to CP | Figure 3 | 2.7 | 16 | 5 | - | 19 | - | ns |
| | | 1 | 3.0 to 3.6 | 13 | 42 | - | 15 | - | |
| | | | 1.2 | - | -10 | - | - | - | |
| 4. | Hold time | Figure 3 | 2.0 | 5 | -4 | - | 5 | - | ns |
| t _h | D _n to CP | Figure 3 | 2.7 | 5 | -3 | - | 5 | - | 115 |
| | | | 3.0 to 3.6 | 5 | -22 | - | 5 | - | |
| | | + | 2.0 | 14 | 40 | - | 12 | - | |
| f _{max} | Maximum clock pulse frequency | Figure 1 | 2.7 | 19 | 75 | - | 16 | - | MHz |
| | - 2.555400110) | | 3.0 to 3.6 | 24 | 100 ² | - | 20 | - | |

NOTE:

- 1. Unless otherwise stated, all typical values are at T_{amb} = 25°C.
- 2. Typical value measured at V_{CC} = 3.3V.
- 3. Typical value measured at $V_{CC} = 5.0V$.

^{1.} All typical values are measured at T_{amb} = 25°C.

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AC WAVEFORMS

 V_M = 1.5V at $V_{CC} \ge 2.7V \le 3.6V$ V_M = 0.5V * V_{CC} at $V_{CC} < 2.7V$ and $\ge 4.5V$ V_{OL} and V_{OH} are the typical output voltage drop that occur with the output lead

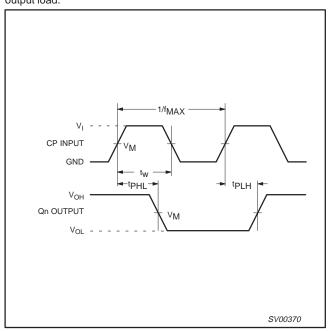


Figure 1. The clock (CP) to output (\mathbf{Q}_n) propagation delays, the clock pulse width and the maximum clock pulse frequency

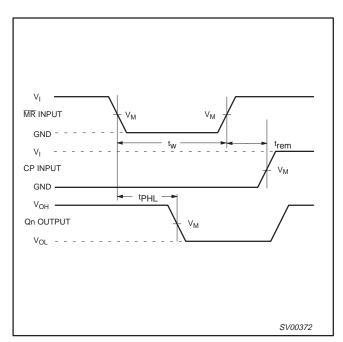


Figure 2. The master reset (\overline{MR}) pulse width, the master reset to output (Q_n) propagations delay and the master reset to clock (CP) removal time

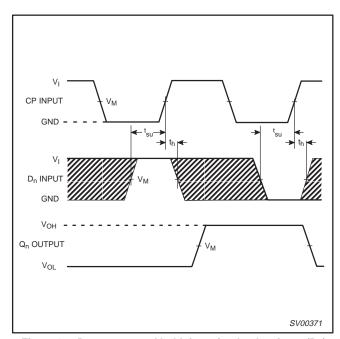


Figure 3. Data set-up and hold times for the data input (D_n)

NOTE:

The shaded areas indicate when the input is permitted to change for predictable output performance.

TEST CIRCUIT

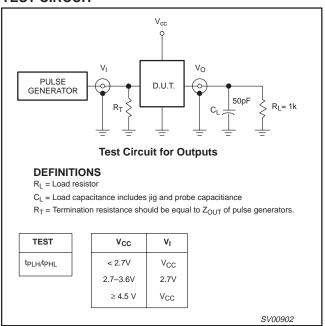


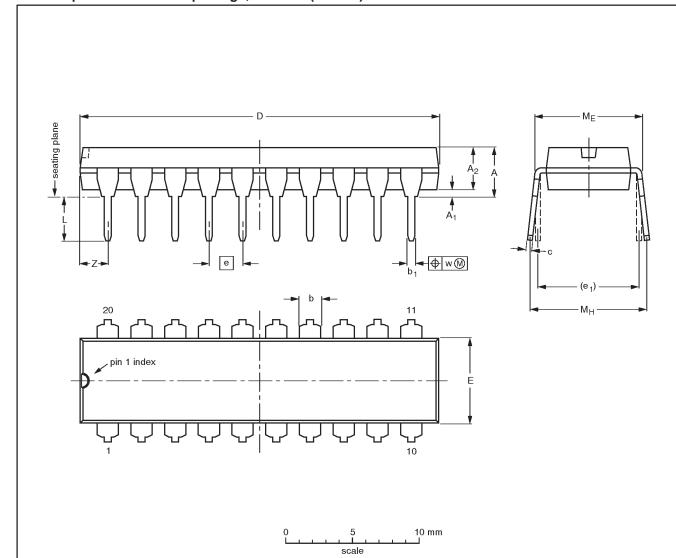
Figure 4. Load circuitry for switching times

Octal D-type flip-flop with reset; positive edge-trigger

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DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | С | D ⁽¹⁾ | E ⁽¹⁾ | е | e ₁ | L | ME | Мн | w | Z ⁽¹⁾ max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|--------------|--------------|-------|--------------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 0.36 0.23 | 26.92 26.54 | 6.40 6.22 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 2.0 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.014 0.009 | 1.060 1.045 | 0.25 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.078 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

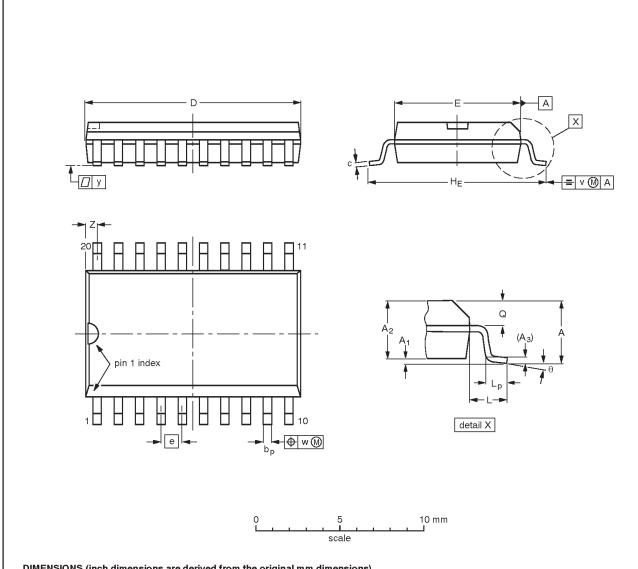
| OUTLINE | | REFER | ENCES | PROJECTIO | EUROPEAN | ISSUE DATE |
|----------|-----|-------|-------|-----------|------------|----------------------------------|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE |
| SOT146-1 | | | SC603 | | | -92-11-17 95-05-24 |

Octal D-type flip-flop with reset; positive edge-trigger

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plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | Α1 | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | z ⁽¹⁾ | θ |
|--------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|------------|------|------|-------|------------------|----|
| mm | 2.65 | 0.30 0.10 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° |
| inches | 0.10 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.050 | 0.42 0.39 | 0.055 | 0.043 0.016 | | 0.01 | 0.01 | 0.004 | 0.035 0.016 | 0° |

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

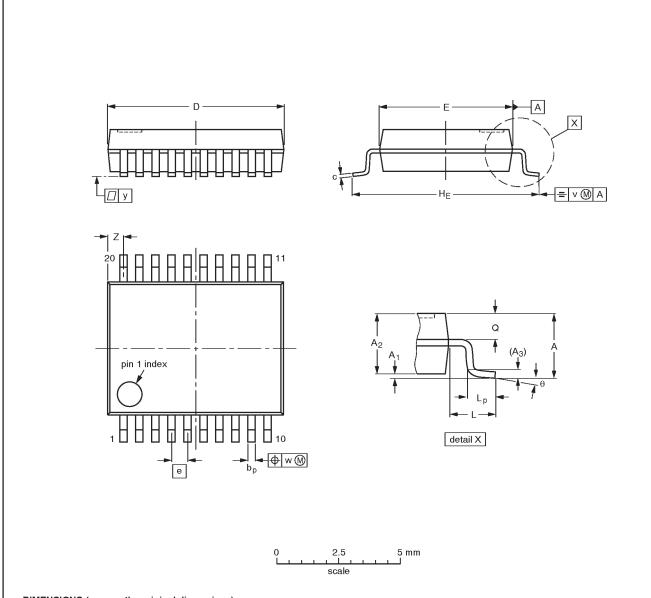
| | OUTLINE | | EUROPEAN | ISSUE DATE | | | |
|---|----------|--------|----------|------------|------------|----------------------------------|--|
| , | VERSION | IEC | JEDEC | EIAJ | PROJECTION | ISSUE DATE | |
| | SOT163-1 | 075E04 | MS-013AC | | | -92-11-17 95-01-24 | |

Octal D-type flip-flop with reset; positive edge-trigger

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | Α1 | A ₂ | A ₃ | bр | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|--------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2.0 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 7.4 7.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 0.9 0.5 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

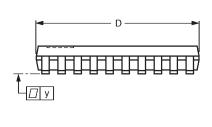
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|-----|----------|------------|------------|--|---------------------------------|
| VERSION | IEC | JEDEC | PROJECTION | | | |
| SOT339-1 | | MO-150AE | | | | 93-09-08 95-02-04 |

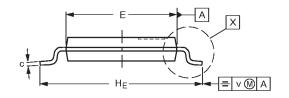
Octal D-type flip-flop with reset; positive edge-trigger

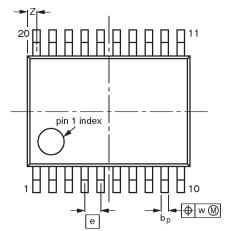
74LV273

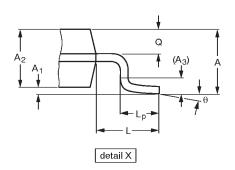
TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1











DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | рb | С | D ⁽¹⁾ | E ⁽²⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|-----------------------|--------------|------------|------------------|------------------|------|------------|-----|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.10 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 6.6 6.4 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1.0 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ICCUE DATE | | | |
|----------|-----|----------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE | |
| SOT360-1 | | MO-153AC | | | | 93-06-16 95-02-04 | |

Octal D-type flip-flop with reset; positive edge-trigger

74LV273

| DEFINITIONS | | | | | | | |
|---------------------------|------------------------|--|--|--|--|--|--|
| Data Sheet Identification | Product Status | Definition | | | | | |
| Objective Specification | Formative or in Design | This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice. | | | | | |
| Preliminary Specification | Preproduction Product | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. | | | | | |
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print code

Date of release: 05-96

Document order number:

9397-750-04443

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